International

#### AN INFINEON TECHNOLOGIES COMPANY

## AUTOMOTIVE GRADE

# AUIRFN8403

HEXFET<sup>®</sup> POWER MOSFET

#### Features

- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified \*

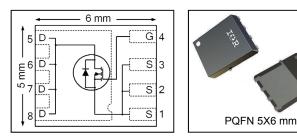
#### Description

Specifically designed for Automotive applications, this HEXFET<sup>®</sup> Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this product an extremely efficient and reliable device for use in Automotive and wide variety of other applications.

#### Applications

- Electric Power Steering (EPS)
- Battery Switch
- Start/Stop Micro Hybrid
- Heavy Loads
- DC-DC Converter

V <sub>DSS</sub>	40V
R <sub>DS(on)</sub> typ.	<b>2.5m</b> Ω
max	3.3mΩ
D (Silicon Limited)	123A©
D (Package Limited)	95A



G	D	S
Gate	Drain	Source

Base Part Number	Package Type	Standard	Orderable Part Number	
		Form Quantity		
AUIRFN8403	PQFN 5mm x 6mm	Tape and Reel	4000	AUIRFN8403TR

#### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C(Bottom)</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)	123©	
I <sub>D</sub> @ T <sub>C(Bottom)</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited)	876	А
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Package Limited)	956	A
I <sub>DM</sub>	Pulsed Drain Current ①	492	
P <sub>D</sub> @T <sub>A</sub> = 25°C	Power Dissipation	4.3	۱۸/
P <sub>D</sub> @T <sub>C(Bottom)</sub> = 25°C	Power Dissipation	94	W
	Linear Derating Factor	0.029	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Thermally Limited) 2	100	mJ
E <sub>AS</sub> (Tested)	Single Pulse Avalanche Energy 2	159	
I <sub>AR</sub>	Avalanche Current ①	See Fig. 14, 15, 22a, 22b	А
E <sub>AR</sub>	Repetitive Avalanche Energy ①		
TJ	Operating Junction and	-55 to + 175	°C
T <sub>STG</sub>	Storage Temperature Range		U

HEXFET® is a registered trademark of International Rectifier. \*Qualification standards can be found at http://www.irf.com/

### **Thermal Resistance**

Symbol	Parameter	Тур.	Max.	Units
R <sub>0JC</sub> (Bottom)	Junction-to-Case ④		1.6	
R <sub>θJC</sub> (Top)	Junction-to-Case ④		31	°C/W
$R_{ ext{ heta}JA}$	Junction-to-Ambient S		35	C/VV
R <sub>0JA</sub> (<10s)	Junction-to-Ambient		23	

## Static Electrical Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	40			V	$V_{GS} = 0V, I_{D} = 250\mu A$
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		26		mV/°C	Reference to $25^{\circ}$ C, I <sub>D</sub> = 2.0mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		2.5	3.3	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 50A
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.6		3.9	V	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$
				1.0	^	$V_{DS} = 40V, V_{GS} = 0V$
IDSS	Drain-to-Source Leakage Current			150	μA	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			100		V <sub>GS</sub> = 20V
	Gate-to-Source Reverse Leakage			-100	Ω	V <sub>GS</sub> = -20V
R <sub>G</sub>	Internal Gate Resistance		1.5			

 RG
 Internal Gate Resistance
 —
 1.5

 Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

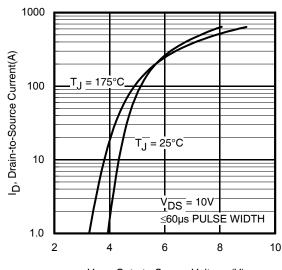
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
gfs	Forward Transconductance	159			S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 50A
$Q_{g}$	Total Gate Charge		65	98		I <sub>D</sub> = 50A
$Q_{gs}$	Gate-to-Source Charge		16			$V_{DS} = 20V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		23		nC	V <sub>GS</sub> = 10V
Q <sub>sync</sub>	Total Gate Charge Sync. (Q <sub>g</sub> - Q <sub>gd</sub> )		42			
t <sub>d(on)</sub>	Turn-On Delay Time		11			V <sub>DD</sub> = 20V
t <sub>r</sub>	Rise Time		37			I <sub>D</sub> = 30A
t <sub>d(off)</sub>	Turn-Off Delay Time		33		ns	$R_{G} = 2.7\Omega$
t <sub>f</sub>	Fall Time		26			V <sub>GS</sub> = 10V ③
C <sub>iss</sub>	Input Capacitance		3174			V <sub>GS</sub> = 0V
C <sub>oss</sub>	Output Capacitance		479			V <sub>DS</sub> = 25V
C <sub>rss</sub>	Reverse Transfer Capacitance		332		pF	<i>f</i> = 1.0 MHz
C <sub>oss</sub> eff. (ER)	Effective Output Capacitance (Energy Related)		637			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V \otimes$
C <sub>oss</sub> eff. (TR)	Effective Output Capacitance (Time Related)		656			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V \bigcirc$
Diada Charac	toriotico					

**Diode Characteristics** 

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
1	Continuous Source Current			1236	^	MOSFET symbol
I <sub>S</sub>	(Body Diode)				A	showing the
1	Pulsed Source Current			492	•	integral reverse
I <sub>SM</sub>	(Body Diode) ①				A	p-n junction diode.
V <sub>SD</sub>	Diode Forward Voltage		0.9	1.3	V	$T_J$ = 25°C, $I_S$ = 50A, $V_{GS}$ = 0V ③
dv/dt	Peak Diode Recovery		2.4		V/ns	T <sub>J</sub> = 175°C, I <sub>S</sub> = 50A, V <sub>DS</sub> = 40V
+	Boyorga Bogoyony Timo		16		20	$T_{\rm J} = 25^{\circ}C$ $V_{\rm R} = 34V$ ,
t <sub>rr</sub>	Reverse Recovery Time		18		ns	$T_{\rm J} = 125^{\circ}C$ $I_{\rm F} = 50A$
0	Boyorgo Bogoyony Chargo		5.0		nC	$T_{J} = 25^{\circ}C$ di/dt = 100A/µs <sup>3</sup>
Q <sub>rr</sub>	Reverse Recovery Charge		6.9		nc	$T_J = 125^{\circ}C$
I <sub>RRM</sub>	Reverse Recovery Current		0.50		А	T <sub>J</sub> = 25°C

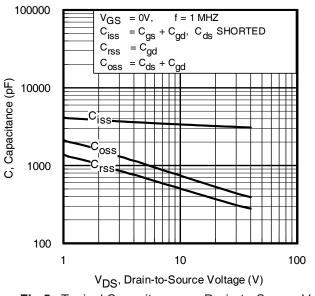
#### 1000 VGS 15V 10V 8.0V TOF I<sub>D</sub>, Drain-to-Source Current (A) 7.0V 6.0V 5.5V 5.0V 100 BOTTON 4.5V 10 ≤60µs PULSE WIDTH = 25°C Ti 1 0.1 1 10 100 V<sub>DS</sub>, Drain-to-Source Voltage (V)

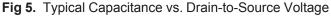
Fig. 1 Typical Output Characteristics



 $V_{GS}$ , Gate-to-Source Voltage (V)

Fig. 3 Typical Transfer Characteristics





# AUIRFN8403

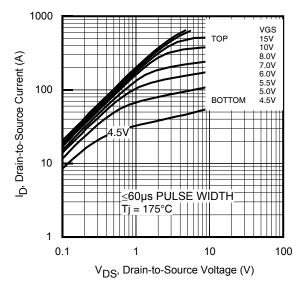
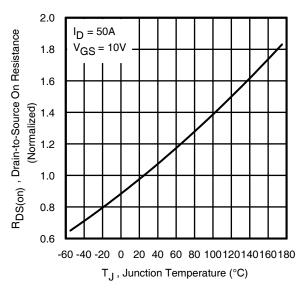
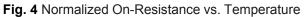


Fig. 2 Typical Output Characteristics





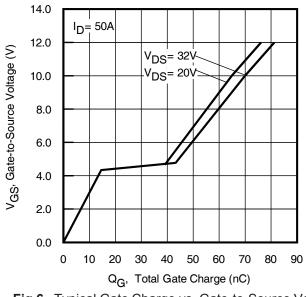


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

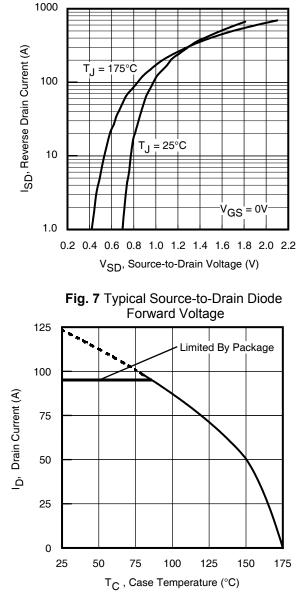
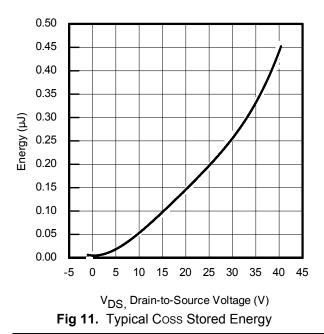


Fig 9. Maximum Drain Current vs. Case Temperature



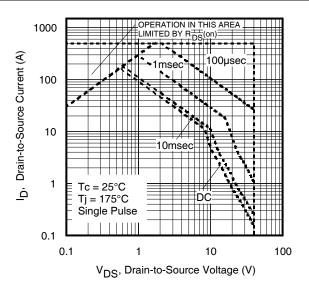


Fig 8. Maximum Safe Operating Area

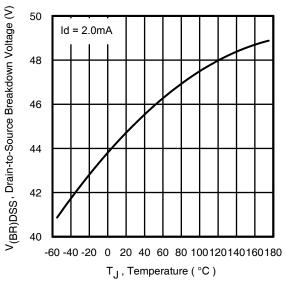


Fig 10. Drain-to-Source Breakdown Voltage

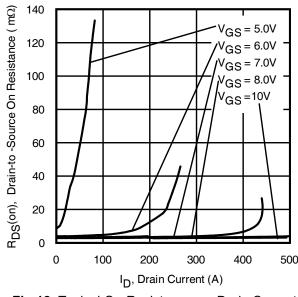


Fig 12. Typical On-Resistance vs. Drain Current



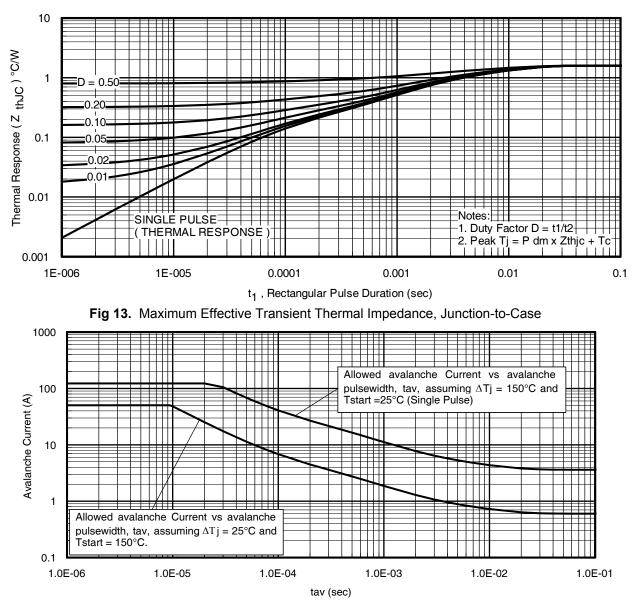


Fig 14. Typical Avalanche Current vs. Pulse Width

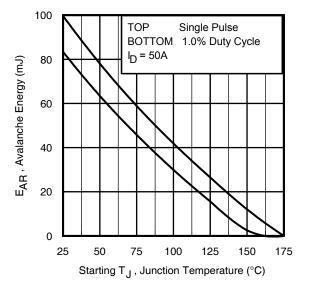


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

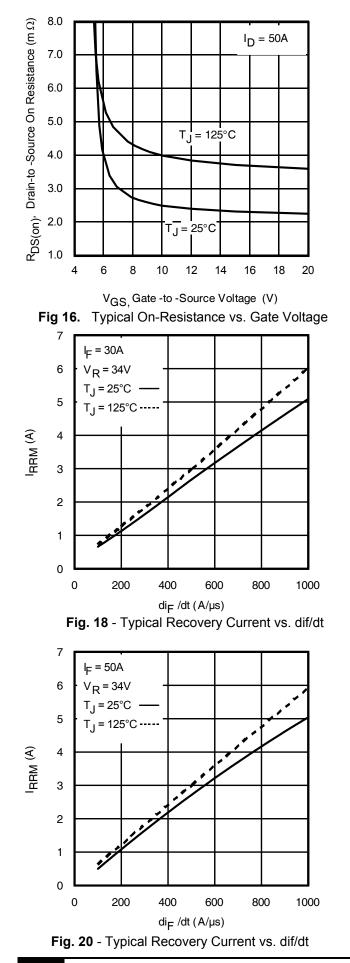
- Avalanche failures assumption: Purely a thermal phenomenon and failure occurs at a temperature far in excess of T<sub>jmax</sub>. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long as T<sub>jmax</sub> is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
- 4. PD (ave) = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. Iav = Allowable avalanche current.
- 7.  $\Delta T$  = Allowable rise in junction temperature, not to exceed T<sub>jmax</sub> (assumed as 25°C in Figure 14, 15).

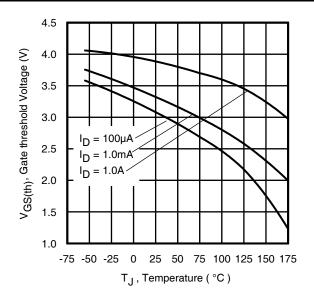
tav = Average time in avalanche.

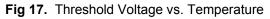
D = Duty cycle in avalanche = tav ·f

ZthJC(D, tav) = Transient thermal resistance, see Figures 13)

$$\begin{split} \textbf{P}_{D (ave)} &= 1/2 \ ( \ 1.3 \cdot \textbf{BV} \cdot \textbf{I}_{av}) = \Delta T/ \ \textbf{Z}_{thJC} \\ \textbf{I}_{av} &= 2\Delta T/ \ [ 1.3 \cdot \textbf{BV} \cdot \textbf{Z}_{th} ] \\ \textbf{E}_{AS (AR)} &= \textbf{P}_{D (ave)} \cdot \textbf{t}_{av} \end{split}$$







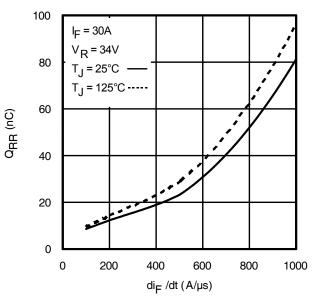
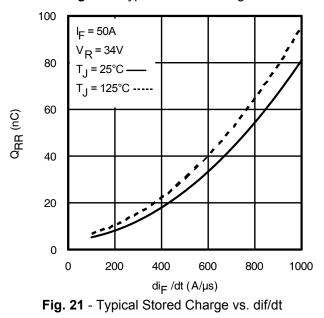
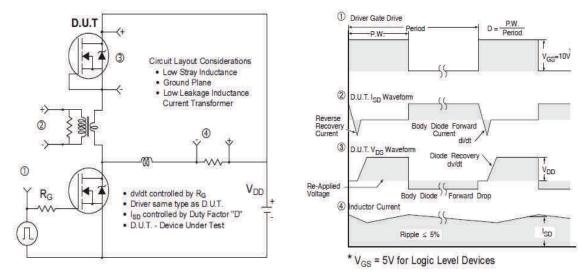
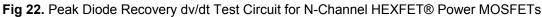


Fig. 19 - Typical Stored Charge vs. dif/dt







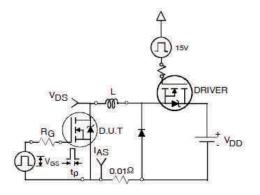


Fig 22a. Unclamped Inductive Test Circuit

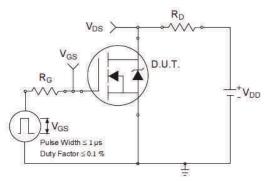


Fig 23a. Switching Time Test Circuit

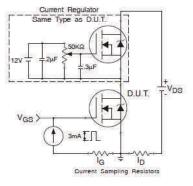


Fig 24a. Gate Charge Test Circuit

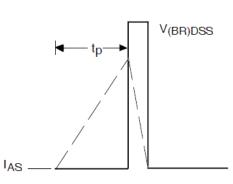


Fig 22b. Unclamped Inductive Waveforms

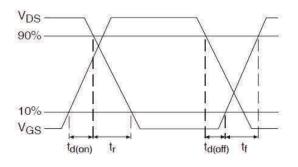
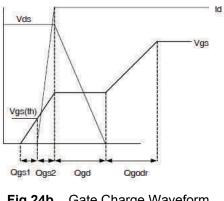


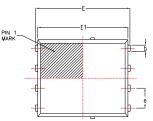
Fig 23b. Switching Time Waveforms



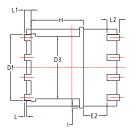
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## PQFN 5x6 Outline "E" Package Details





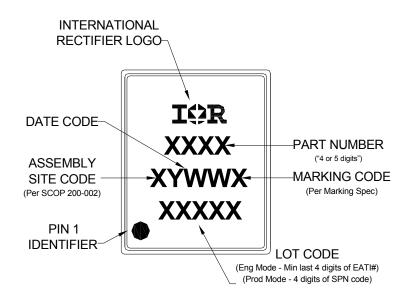
TOP VIEW



BOTTOM VIEW

For footprint and stencil design recommendations, please refer to application note AN-1136 at <u>http://www.irf.com/technical-info/appnotes/an-1136.pdf</u> For visual inspection recommendations, please refer to application note AN-1154 at <u>http://www.irf.com/technical-info/appnotes/an-1154.pdf</u>

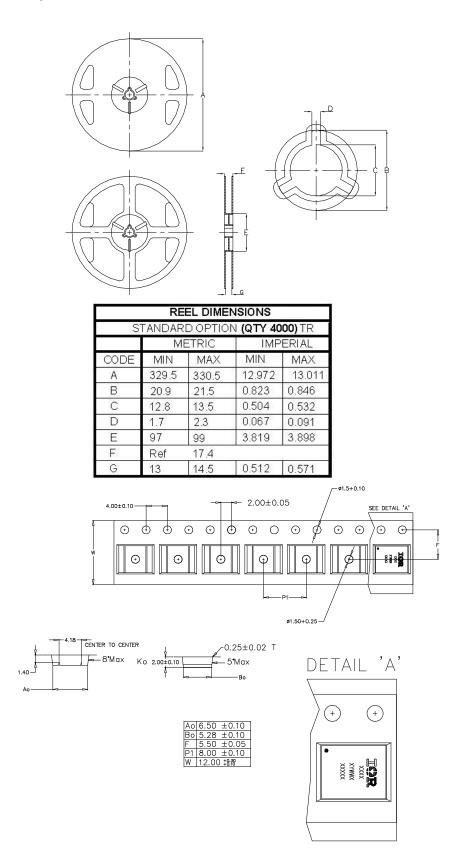
# PQFN 5x6 Outline "E" Part Marking



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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# PQFN 5x6 Outline "E" Tape and Reel



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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## **Qualification Information<sup>†</sup>**

		Automotive (per AEC-Q101)				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		PQFN 5mm x 6mm	MSL1			
	Machine Model	Class M3 (+/- 400V) <sup>††</sup>				
		AEC-Q101-002				
	Human Body Model	Class H1C (+/- 2000V) <sup>††</sup>				
ESD		AEC-Q101-001				
	Charged Device Model	el Class C5 (+/- 2000V) <sup>††</sup>				
			AEC-Q101-005			
RoHS Compliant		Yes				

† Qualification standards can be found at International Rectifier's web site: <u>http://www.irf.com/</u>

†† Highest passing voltage.

### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting  $T_J = 25^{\circ}C$ , L =0.080mH,  $R_G = 50\Omega$ ,  $I_{AS} = 50A$ .
- ③ Pulse width  $\leq$  400µs; duty cycle  $\leq$  2%.
- A R<sub> $\theta$ </sub> is measured at TJ of approximately 90°C.
- S When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994: <u>http://www.irf.com/technical-info/appnotes/an-994.pdf</u>
- © Calculated continuous current based on maximum allowable junction temperature.
- ⑦ Coss eff. (TR) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 to 80% VDSS.
- Oss eff. (ER) is a fixed capacitance that gives the same energy as Coss while VDS is rising from 0 to 80% VDSS.

## **Revision History**

Date	Comments			
05/08/2014	Updated typo on "Description" on page 1.			
07/08/2014	<ul> <li>• Updated typo on Gate Charge units from "S" to "nC" on page 2.</li> <li>• Removed extra GFS from Electrical Table on page 2.</li> </ul>			
07/08/2015	<ul> <li>Corrected V<sub>GS(th)</sub> min from 2.2V to 2.6V on page 2.</li> <li>Updated "IFX logo" on all pages.</li> </ul>			
09/01/2015	09/01/2015 • Corrected dv/dt from "1.3V/ns" to "2.4V/ns" on page 2.			

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